

PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

EPAS ID: PAT3152899

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
WEI KEONG CHAN	12/05/2014
RECEIVING PARTY DATA	
Name:	Freescale Semiconductor, Inc.
Street Address:	6501 William Cannon Drive West
Internal Address:	Law Department
City:	Austin
State/Country:	TEXAS
Postal Code:	78735
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14574398
CORRESPONDENCE DATA	
Fax Number:	(512)895-6630
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	512-895-6979
Email:	USADOCKETING@freescale.com
Correspondent Name:	DEE MATOCHA
Address Line 1:	6501 WILLIAM CANNON DRIVE WEST
Address Line 2:	TX30/OE62
Address Line 4:	AUSTIN, TEXAS 78735
ATTORNEY DOCKET NUMBER:	MT12871AK
NAME OF SUBMITTER:	CHARLES BERGERE
SIGNATURE:	/ charles bergere /
DATE SIGNED:	12/18/2014
Total Attachments: 2	
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ASSIGNMENT AND AGREEMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, I, **WAI KEONG CHAN OF MALAYSIA**, have sold, assigned and transferred, and do hereby sell, assign and transfer, unto **FREESCALE SEMICONDUCTOR, INC.**, a corporation of the State of Delaware, having its principal office in Austin, State of Texas, United States of America, and its successors, assigns, and legal representatives, the entire right, title and interest for the United States of America in and to certain inventions relating to improvements in **SEQUENTIAL ACCESS ASSEMBLY STRIP TEST ADAPTER** (Docket No. **MT12871AK**), described, illustrated and claimed in an application for Letters Patent of the United States of America executed by us on the dates indicated by our signatures below, together with the entire right, title and interest in and to the application, and in and to Letters Patent that may be issued upon the application, and upon any division, extension, continuation or reissue thereof.

I hereby also sell, assign and transfer unto **FREESCALE SEMICONDUCTOR, INC.**, the entire right, title and interest in and to the invention and in and to applications for Letters Patent therefor in all countries foreign to the United States of America, including all rights under any and all international conventions and treaties in respect of the invention and the applications for Letters Patent in foreign countries, and I further authorize **FREESCALE SEMICONDUCTOR, INC.** to apply for Letters Patent in foreign countries directly in its own name, and to claim priority of the filing date of the application for Letters Patent of the United States of America under the provisions of any and all international conventions and treaties.

I hereby authorize and request the Commissioner of Patents of the United States of America to issue Letters Patent upon the aforesaid application, division, extension, continuation or reissue, to **FREESCALE SEMICONDUCTOR, INC.**, for the sole use and benefit of **FREESCALE SEMICONDUCTOR, INC.**, its successors, assigns and legal representatives, to the full end of the term for which Letters Patent may be granted, the same as they would have been held and enjoyed by me had this assignment not been made, and I hereby authorize and request the equivalent authorities in foreign countries to issue the patents of their respective countries to **FREESCALE SEMICONDUCTOR, INC.**

I agree that, when requested, we will, without charge to **FREESCALE SEMICONDUCTOR, INC.**, but at its expense, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable or convenient for securing and maintaining patents for the inventions in any and all countries and for vesting title thereto in **FREESCALE SEMICONDUCTOR, INC.**, its successors, assigns and legal representatives or nominees.

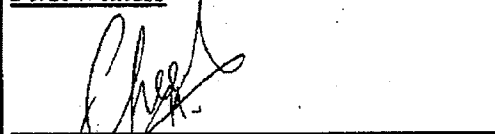
I covenant with FREESCALE SEMICONDUCTOR, INC., its successors, assigns and legal representatives, that the interest and property hereby conveyed is free from all prior assignment, grant, mortgage, license or other encumbrance.



DATE: 05 Dec 2014

WEI KEONG CHAN

First Witness



SIGNATURE OF WITNESS

DATE: Dec 05, 2014
(Month-Day-Year)

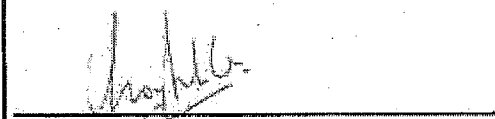
Chee Voon Seng

PRINTED NAME OF WITNESS

34, Jalan Perangin Timor II, Taman Ipoh Baru, 31400 IPOH, Perak.

PRINTED ADDRESS OF WITNESS

Second Witness



SIGNATURE OF WITNESS

DATE: Dec 5, 2014
(Month-Day-Year)

CHONG KOK GIN

PRINTED NAME OF WITNESS

A-9-2 MONT KIARA AMAN, JLN KIARA 2, 50450, K.L.

PRINTED ADDRESS OF WITNESS